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Sharp Microelectronics GP1S36J0000F

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Datasheet of GP1S36J0000F - SNSR TILT 2PHASE 75-90DEG 20MATH

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GP1S36J0000F

GP1S36J0000F

Phototransistor Output, Transmissive Photointerrupter with Tilt Direction (3-direction) **Detecting**

■ Description

GP1S36J0000F is a compact-package, phototransistor output, transmissive photointerrupter, with opposing emitter and detector in a molding that provides noncontact sensing.

This is a 2-phase output device, suitable for detection of the position (3 direction).

■ Features

- 1. Transmissive with phototransistor output
- 2. Highlights:
 - Built-in a ball (2 phase output)
 - Compact
 - PWB mounting type
 - · 3-direction detection
- 3. Lead free and RoHS directive compliant

■Agency approvals/Compliance

1. Compliant with RoHS directive

■ Applications

- 1. General purpose detection of device direction.
- 2. Example: Camera, DSC, Camcorder, Robot

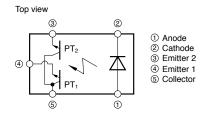
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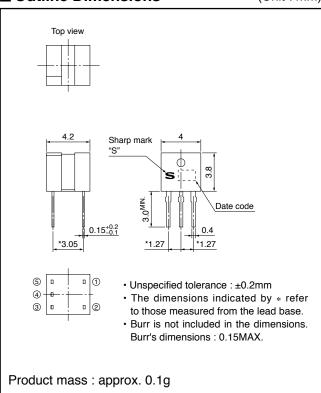


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■ Internal Connection Diagram



■ Outline Dimensions (Unit: mm)



Plating material: SnCu (Cu: TYP. 2%)



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Date code (2 digit)								
1st o	digit	2nd digit						
Year of p	roduction	Month of production						
A.D.	Mark	Month	Mark					
2000	0	1	1					
2001	1	2	2					
2002	2	3	3					
2003	3	4	4					
2004	4	5	5					
2005	5	6	6					
2006	6	7	7					
2007	7	8	8					
2008	8	9	9					
2009	9	10	X					
2010	0	11	Y					
:	:	12	Z					

repeats in a 10 year cycle

Country of origin Japan, China

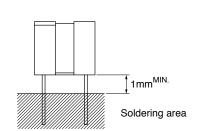
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■ Absolute Maximum Ratings $(T_a=25^\circ$						
	Parameter	Symbol	Rating	Unit		
	Forward current		50	mA		
Input	Reverse voltage	V_R	6	V		
	Power dissipation	P	75	mW		
	Collector-emitter voltage	V _{CE1O}	35	V		
	Concetor-ennuer voltage	V _{CE2O}	33	v		
Output	Emitter-collector voltage	V _{E1CO}	6	V		
Output	Ellitter-conector voltage	V _{E2CO}				
	Collector current	I_{C}	20	mA		
	Collector power dissipation	P _C	75	mW		
Total j	power dissipation	P _{tot}	100	mW		
Opera	ting temperature	Topr	-25 to +85	°C		
Storag	ge temperature	T_{stg}	-40 to +100	°C		
*1Solde	ring temperature 1	T _{sol}	260	°C		
*2Solde	ring temperature 2	T _{sol}	320	°C		



■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

	Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit		
Innut	Forward voltage		Forward voltage		V_F	$I_{F}=20\text{mA}$	_	1.2	1.4	V
Input Reverse current			I_R $V_R=3V$		_	_	10	μΑ		
*3Output	Dark current		I_{CEO}	V _{CE} =20V	_	_	100	nA		
	Collector current		I_{C}	$V_{CE}=5V$, $I_{F}=5mA$	60	_	350	μΑ		
*3Transfer	*4Leak current		I _{LEAK}	$V_{CE}=5V$, $I_F=5mA$	_	_	15	μΑ		
charac-	Collector-emitter saturation voltage		V _{CE(sat)}	$I_{F}=10\text{mA}, I_{C}=60\mu\text{A}$	_	_	0.4	V		
teristics	Response time Response time Rise time Fall time		t _r	V 5V I 100A D 11c0	_	50	150	μs		
			$t_{\rm f}$	V_{CE} =5 V , I_{C} =100 μ A, R_{L} =1 $k\Omega$	_	50	150	μs		

^{*3} Output and coupling characteristics are common to the both phototransistors.

 $^{^{\}circ}1$ For MAX. 5 s (Soldering area is shown below) $^{\circ}2$ For MAX. 2 s (Eachterriral shall be hand-soldered at more 0.8mm for from bottom of resin pack-

^{*4} Characteristics except leak current is measured at θ =0°, ϕ =0°. Leak current is the output current of transistor when θ =±90°, ϕ =0° and I_C =OFF.



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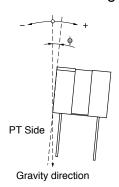
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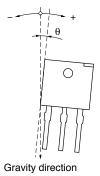
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■ Absolute Maximum Ratings						$(I_F=5mA)$	A, V _{CC}	=5V,	φ≤±5)	
θ	$\begin{vmatrix} -90^{\circ} \end{vmatrix} \leftrightarrow \begin{vmatrix} -75^{\circ} \end{vmatrix} \leftrightarrow \begin{vmatrix} -15^{\circ} \end{vmatrix} \leftrightarrow \begin{vmatrix} +15^{\circ} \end{vmatrix} \leftrightarrow \begin{vmatrix} +75^{\circ} \end{vmatrix} \leftarrow \end{vmatrix}$								*	+90°
I_{C1}	ON Indefinit						Indefinite		OFF	
I_{C2}		OFF		Indefinite	ON					

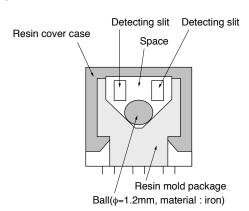
$$\begin{split} &I_{C1}: Output \ current \ of \ phototransistors \ PT_1 \\ &I_{C2}: Output \ current \ of \ phototransistors \ PT_2 \\ &\theta: Device \ condition: \ Refer \ to \ the \ next \ figure \\ &\phi: Device \ condition: \ Refer \ to \ the \ next \ figure \\ &ON: Output \ current \ of \ phototransistors: \ 60 \mu A \ or \ more \\ &OF: \ Output \ current \ of \ phototransistors: \ 15 \mu A \ or \ less \end{aligned}$$

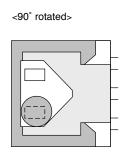
Device state diagram

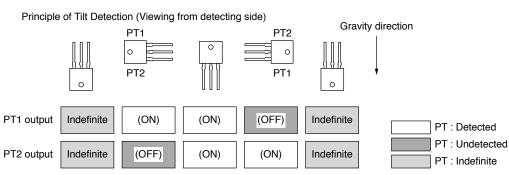




■ Supplement







^{*} Output of ON/OFF is under the condition that the device is in stationary state.



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Fig.1 Forward Current vs.

Ambient Temperature

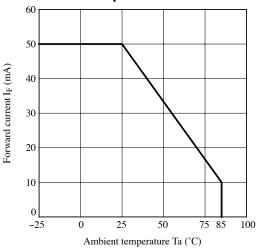


Fig.2 Power Dissipation vs.
Ambient Temperature

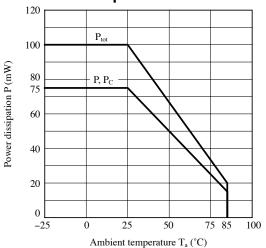


Fig.3 Forward Current vs. Forward Voltage

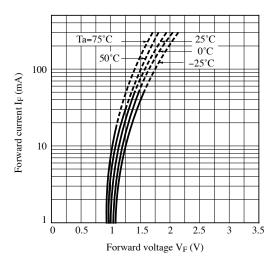


Fig.4 Collector Current vs. Forward Current

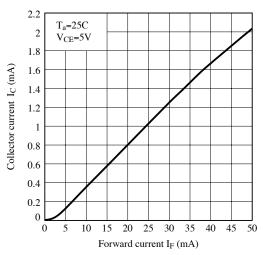


Fig.5 Collector Current vs.
Collector-emitter Voltage

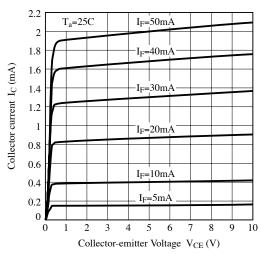
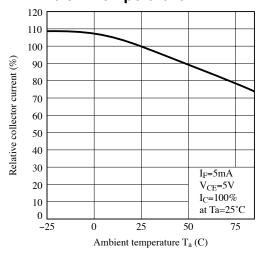


Fig.6 Relative Collector Current vs.

Ambient Temperature



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Fig.7 Collector-emitter Saturation Voltage vs. **Ambient Temperature**

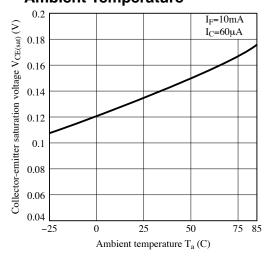


Fig.8 Response Time vs. Load Resistance

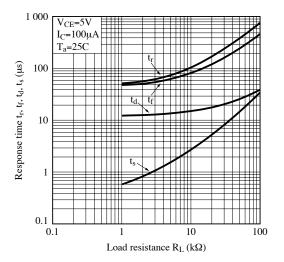


Fig.9 Collector Dark Current vs. **Ambient Temperature**

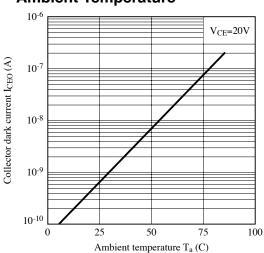
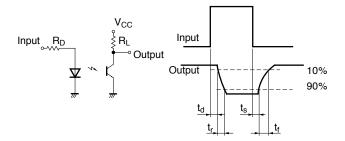


Fig.10 Test Circuit for Response Time



Remarks: Please be aware that all data in the graph are just for reference and not for guarantee.

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■ Design Considerations

Design guide

1) Prevention of malfunction

To prevent photointerrupter from faulty operation caused by external light, do not set the detecting face to the external light.

Please confirm that there is no mis-operation by magnetic field in use, for prevention of mis-operation by magnetic field.

Please don't let the device put in change of temperature that makes dew for prevention of mis-operation by dew.

If the device is put in the change of temperature which makes dew, please leave the device for enough time in the constant temperature for use.

This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photointerrupter will degrade over time.

In the case of long term operation, please take the general IRED degradation (50% degradation over 5 years) into the design consideration.

Parts

This product is assembled using the below parts.

Photodetector (qty.: 1)

Category	Material	Maximum Sensitivity wavelength (nm)	Sensitivity wavelength (nm)	Response time (µs)	
Phototransistor	Silicon (Si)	800	700 to 1 200	12	

• Photo emitter (qty.: 1)

Category Material		Maximum light emitting wavelength (nm)	I/O Frequency (MHz)	
Infrared emitting diode (non-coherent)	Gallium arsenide (GaAs)	950	0.3	

Material

Case	Lead frame	Lead frame plating	Packing case	Metal ball
Black polyphenylene sulfide resin (UL94 V-0)	42Alloy	SnCu plating	Polycarbonate	Fe

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■ Manufacturing Guidelines

Soldering Method

Flow Soldering:

Soldering should be completed below 260°C and within 5 s.

Please solder within one time.

Soldering area is 1mm or more away from the bottom of housing.

Please take care not to let any external force exert on lead pins.

Please don't do soldering with preheating, and please don't do soldering by reflow.

Hand soldering

Hand soldering should be completed within 2 s when the point of solder iron is below 320°C.

Soldering area is 0.8mm or more away from the bottom of housing.

Please solder within one time.

Soldered product shall treat at normal temperature.

Lead pin

Lead terminals of this product are tin copper alloy plated. Before usage, please evaluate solderability with actual conditions and confirm. And the uniformity in color for the lead terminals are not specified.

Other notice

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.

Cleaning instructions

The device shall not be washed with washing material, for there is possibility to remain washing material in internal space of this transmissive type photointerrupter.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this product.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

This product shall not contain the following materials banned in the RoHS Directive (2002/95/EC).

·Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBB), Polybrominated diphenyl ethers (PBDE).



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■ Package specification

Sleeve package

Package materials

Sleeve : Polystyrene

Stopper: Styrene-Butadiene

Package method

MAX. 40 pcs. of products shall be packaged in a sleeve. Both ends shall be closed by tabbed and tabless

stoppers.

MAX. 50 sleeves in one case.

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 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
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